

### MMBT3906T SOT-523 Silicon General Purpose Transistor (PNP)

### **General description**

SOT-523 Silicon General Purpose Transistor (PNP)

#### **FEATURES**

- · Simplifies Circuit Design
- RoHS Compliant
- Green EMC
- Matte Tin(Sn) Lead Finish
- Weight: approx. 0.002g

#### Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise noted)

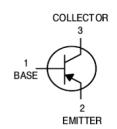
Symbol	Parameter	Value	Units
Vсво	Collector-Base Voltage	-40	V
Vceo	Collector-Emitter Voltage	-40	V
<b>V</b> EBO	Emitter-Base Voltage	-5	V
Ic	Collector Current	-200	mA
P <sub>D</sub>	Power Dissipation (FR-4 Board – minimum pad)	200	mW
Reja	Thermal Resistance from Junction to Ambient	600	°C /W
Тл Тэтс	Junction & Storage Temperature Range	-55 to +150	ů

#### **Green Product**



SOT-523 (SC-75A)

#### **Electrical Symbol:**



#### **Device Marking:**

Device Type	Marking
ММВТЗ906Т	2A or 3N

#### **Off Characteristics**

Oh al	Parameter	Took Condition	Limits		Unit
Symbol		Test Condition	Min	Max	
<b>V</b> (BR)CEO	Collector-Emitter Breakdown Voltage (Note 1)	I <sub>C</sub> =-1mA, I <sub>B</sub> =0A	-40	-	Volts
V(BR)CBO	Collector-Base Breakdown Voltage	I <sub>C</sub> =-10uA, I <sub>E</sub> =0A	-40	-	Volts
V(BR)EBO	Emitter-Base Breakdown Voltage	I <sub>E</sub> =-10uA, I <sub>B</sub> =0A	-5	-	Volts
Івь	Base Cutoff Current	V <sub>CE</sub> =-30V, V <sub>EB</sub> =-3V	-	-50	nA
ICEX	Collector Cutoff Current	V <sub>CE</sub> =-30V, V <sub>EB</sub> =-3V	-	-50	nA

Note 1: Pulse Test. Pulse width <300us, Duty cycle < 2.0%

# **MMBT3906T**



#### **On Characteristics**

Symbol	Parameter	Test Condition	Limits		Unit
			Min	Max	
		Ic =-0.1mA, V <sub>CE</sub> =-1V	60	-	
		I <sub>C</sub> =-1.0mA, V <sub>CE</sub> =-1V	80	-	
H <sub>FE</sub>	DC Current Dain	I <sub>C</sub> =-10mA, V <sub>CE</sub> =-1V	100	300	-
		I <sub>C</sub> =-50mA, V <sub>CE</sub> =-1V	60	-	
		I <sub>C</sub> =-100mA, V <sub>CE</sub> =-1V	30	-	
VCE(sat)	Collector-Emitter Saturation Voltage	Ic=-10mA, I <sub>B</sub> =-1mA	-	0.25	
		I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA	-	0.4	Volts
VBE(sat)	Base-Emitter Saturation Voltage	Ic=-10mA, I <sub>B</sub> =-1mA	0.65	0.85	
		I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA		0.95	Volts

Small-signal Characteristics

Symbol	Parameter	Test Condition	Limits		Unit
		rest Condition	Min	Max	Unit
f⊤	Current-Gain-Bandwidth Product	I <sub>C</sub> =-10mA, V <sub>CE</sub> =-20V, f = 100MHz	250	-	MHz
Cobo	Output Capacitance	$V_{CB} = -5V$ , $I_E = 0A$ , $f = 1.0MHz$	-	4.5	pF
C <sub>ibo</sub>	Input Capacitance	V <sub>BE</sub> =-0.5V, I <sub>C</sub> =0A, f = 1.0MHz	-	10	pF
h <sub>ie</sub>	Input Impedancen	V <sub>CE</sub> =-10V, I <sub>C</sub> =-1mA, f = 1.0kHz	2	12	pF
h <sub>re</sub>	Voltage Feedback Ratio	V <sub>CE</sub> =-10V, I <sub>C</sub> =-1mA, f = 1.0kHz	0.1	10	X10 <sup>-4</sup>
h <sub>fe</sub>	Small-signal Current Gain	V <sub>CE</sub> =-10V, I <sub>C</sub> =-1mA, f = 1.0kHz	100	400	-
hoe	Output Admittance	V <sub>CE</sub> =-10V, I <sub>C</sub> =-1mA, f = 1.0kHz	3	60	θ mhos
NF	Noise Figure	V <sub>CE</sub> =-5V, I <sub>C</sub> =-100uA	4		dB
	Noise rigure	Rs=1.0k Ω f = 1.0kHz		4	ub

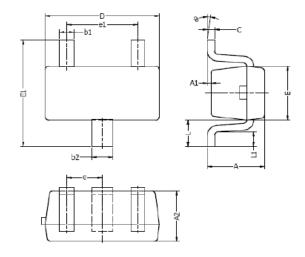
**Switching Characteristics** 

Oll	Parameter	T	Limits		1114
Symbol		Test Condition	Min	Max	Unit
<b>t</b> d	Delay Time	V <sub>CC</sub> =-3V, V <sub>BE</sub> =-0.5V,	-	35	nS
<b>t</b> r	Rise Time	I <sub>C</sub> =-10mA, I <sub>B1</sub> =-1mA	-	35	113
ts	Storage Time	V <sub>CC</sub> =-3V, I <sub>C</sub> =-10mA,	-	225	20
<b>t</b> f	Fall Time	I <sub>B1</sub> = I <sub>B2</sub> =-1mA	-	75	nS

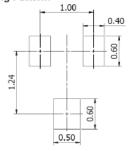
# **MMBT3906T**



#### **SOT-523 PACKAGE OUTLINE**



Typical	Soldering	Pattern:



DIM	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.70	0.90	0.028	0.035
A1	0.00	0.10	0.000	0.004
A2	0.70	0.80	0.028	0.031
b1	0.15	0.25	0.006	0.010
b2	0.25	0.35	0.010	0.014
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
E1	1.45	1.75	0.057	0.069
е	0.50 TYP.		0.020 TYP.	
e1	0.90	1.10	0.035	0.043
L	0.40	0.016 REF.		REF.
L1	0.10	0.30	0.004	0.012
θ	<b>0</b> °	8°	<b>0</b> °	8°

- NOTES:

  1. Above package outline conforms to JEITA EAIJ ED-7500A SC-75A.

  2. Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



## **Important Notice and Disclaimer**

DOESHARE has used reasonable care in preparing the information included in this document, but DOESHARE does not warrant that such information is error free. DOESHARE assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.

DOESHARE no warranty, representation or guarantee regarding the documents, circuits and products specification, DOESHARE reservation rights to make changes for any documents, products, circuits and specifications at any time without notice.

Purchasers are solely responsible for the choice, selection and use of the DOESHARE products and services described herein, and DOESHARE assumes no liability whatsoever relating to the choice, selection or use of the products and services described herein.

No license, express or implied, by implication or otherwise under any intellectual property rights of DOESHARE.

Resale of DOESHARE products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by DOESHARE for the DOESHARE product or service described herein and shall not create or extend in any manner whatsoever, any liability of DOESHARE.